

# TPA3110D2 EVM Audio Amplifier Evaluation Board

This user's guide provides the TPA3110D2 evaluation board specifications and a quick start list for standalone operation. Also included are the schematic, printed-circuit board layout, and bill of materials.

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# 1 Introduction

The TPA3110D2 EVM customer evaluation module demonstrates the integrated circuit TPA3110D2 from Texas Instruments.



Figure 1. The TI TPA3110D2 EVM Audio Power Amplifier – Top View





Figure 2. The TI TPA3110D2 EVM Audio Power Amplifier – Bottom View

# 1.1 TPA3110D2 EVM Specifications

# Table 1. Key Parameters

Key Parameters						
Power Supply Voltage	8 to 26 Volts					
Number of Channels	2 Bridge Tied Load (BTL) Stereo					
Load Impedance Stereo BTL	4 to 8 $\Omega$ (connect 33-µH series inductor for 4 $\Omega$ or 68-µH inductor for 8 $\Omega$ if using the ferrite bead filters)					
Load Impedance Mono PBTL	2 to 8 $\Omega$ (connect series inductors if using with ferrite bead filters)					
Output Power BTL	15 W per channel					
Output Power PBTL	30 W					



# 2 Operation

# 2.1 Quick Start List for Stand-Alone Operation

Follow these steps to use the TPA3110D2 EVM stand-alone or when connecting it into existing circuits or equipment. Connections to the EVM module can be made by inserting stripped wire or banana plugs for the power supply and output connections. The input connectors are RCA phono jacks.

# **Power Supply**

A single power supply is required to power up the EVM. Since most of the pins are PVCC compliant, the PVCC supply can also be used to power the analog supply ( $AV_{CC}$ ) and can be used to pull up the logic pins for shutdown (SD) control, fault detection (FAULT), gain (GAIN0 and GAIN1), and PBTL as long as the voltage slew rate is limited to 10 V/ms. GVDD is an internally generated supply for the output FETs and is also used to power the PLIMIT voltage divider circuit on the EVM. PLIMIT is GVDD compliant, but not PVCC compliant. PLIMIT can also be powered by an external supply connected to the PLIMIT pin. Take care not to power the PLIMIT pin (or connect power to the GVDD pin inadvertently through the PLIMIT network) when the PVCC supply is turned off. This can cause damage to the IC.

Table 2.	Power	Supply	Requirements
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Description	Voltage Range	Current Requirements	Minimum Wire Size	
PVCC	8 to 26 V	3 A	24 AWG	

### **Evaluation Module Preparations**

- 1. Ensure that the external power source is set to OFF.
- 2. Connect the external regulated power supply adjusted from 8V to 26V to the module PVCC and GND banana jacks taking care to observe marked polarity.

# **Inputs and Outputs**

- 1. For a BTL Configuration, connect a Load(s) across the outputs (LEFT+ and LEFT-) and (RIGHT+ and RIGHT-). For PBTL configuration, connect a single load from one of the left speaker jacks to one of the right speaker jacks depending on how the filters are loaded.
- Connect audio inputs, either differential or single-ended, to the LIN and RIN RCA phono plugs for BTL operation. For PBTL operation, apply a single input, differential or single-ended, to the RIN RCA phono plug.

### **Control Inputs**

1. Ensure the mode jumpers, PBTL, GAIN0, GAIN1, are set correctly depending on the desired operating state. Also, make sure to connect the left outputs together and the right outputs together at the LEFT and RIGHT molex connectors if PBTL operation is desired.

# **Power Up**

- 1. Verify correct voltage and input polarity and turn the external power supplies  $\ensuremath{\mathsf{ON}}$ 
  - The EVM should begin operation.
- 2. Adjust the audio source for the correct volume and enjoy!

Control	Function	Options	Notes
JP1	Allow amp to self reset after short- circuit protection event	Insert jumper for self reset. Leave off for latched SC fault	For latched SC fault, cycle power to reset the fault latch.
GAIN1/GAIN0	Controls amp gain	Insert jumper for zero state (low), Leave off for one state (high)	00 = 20 dB (GAIN1, GAIN0) 01 = 26 dB 10 = 32 dB 11 = 36 dB
JP2	Defeats PLIMIT function and allows amp to run at full power.	Insert jumper for PLIMIT defeat	JP2 connects PLIMIT directly to GVDD
R7	Adjust PLIMIT (an external voltage can also be applied to the PLIMIT test point)		The output voltage rails will be limited to approximately 4X the voltage at the PLIMIT pin. Take care not to apply power to PLIMIT when the PVCC source is off.
PBTL	Sets the amplifier in PBTL mode	Insert jumper to defeat PBTL mode and run in normal stereo BTL mode.	If PBTL jumper is removed (PBTL mode), the Left outputs (OUTPL and OUTNL) as well as the Right outputs (OUTPR and OUTNR) are synchronized and in phase. This allows them to be connected together before the reconstruction filter for PBTL operations. For PBTL operation, connect the OUTPL and OUTNL to each other and connect the OUTPR and OUTNR to each other. This can be done by shorting the two pins of the molex connectors labeled LEFT and RIGHT.
JP3, JP4, JP5, and JP6	Connects LC filters to outputs.		The LC filters are not installed in this version of the EVM. However, the inductors are shipped with the EVM package. They can be installed and used as normal reconstruction filters or to smooth the audio waveforms for measurement. They can also be used when driving resistive loads to simulate a speaker load. This EVM is meant to demonstrate filter-free operation with just a ferrite bead and small capacitor for good EMI performance.

# Table 3. TPA3110D2 Control Guide



# 3 Schematic, Layout, and Bill of Materials

3.1 TPA311D2 EVM Schematic



Figure 3. TPA311D2 EVM Schematic



# 3.2 TPA3110D2 EVM PCB Layers



Figure 4. TPA3110D2 EVM – Top Side Layout





Figure 5. TPA3110D2 EVM – Bottom Side Layout



# 3.3 TPA3110D2 Bill of Materials

# Table 4. Bill of Materials for TPA3110D2EVM

Item	MANU Part no.	QTY	REF DESIGNATORS	Vendor Part No	Description	Vendor	MANU		
	TI-SEMICONDUCTORS								
1	TPA3110D2PWP	1	U1	TPA3110D2PWP	15-W STEREO CLASS-D AUDIO POWER AMP, TSSOP28-PWP ROIHS	TEXAS INSTRUMENTS	TEXAS INSTRUMENTS		
				CAPACITORS					
2	ECJ-1VC1H331J	4	C14, C15, C16, C17	PCC331ACVCT	CAP SMD0603 CERM 330PFD 50V 5% COG ROHS	DIGI-KEY	PANASONIC		
3	C1608C0G1H102J	6	C6, C11, C20, C21, C22, C23	445-1293-1	CAP SMD0603 CERM 1000PFD 50V 5%COG ROHS	DIGI-KEY	TDK CORP.		
4	C1608X7R1H104K	2	C12,C18	445-1314-1	CAP SMD0603 CERM 0.1UFD 50V X7R ROHS	DIGI-KEY	TDK		
5	EMK105BJ224KV-F	4	C7,C8,C9,C10	587-1452-1	CAP SMD0402 CERM 0.22ufd 16V X5R ROHS	DIGI-KEY	TAIYO YUDEN		
6	C0603C105K4PACTU	6	C1,C2,C3,C4,C28,C29	399-5090-1	CAP SMD0603 CERM 1.0ufd 16V 10% X5R ROHS	DIGI-KEY	KEMET		
7	GMK107BJ105KA-T	1	C5	587-1437-1	CAP SMD0603 CERM 1.0ufd 35V 10% X5R ROHS	DIGI-KEY	TAIYO YUDEN		
8	EEE-1VA101XP	2	C13,C19	PCE3951CT	CAP SMD ELECT 100ufd 35V 20% VS-D8 ROHS	DIGI-KEY	PANASONIC		
				RESISTORS		I	-		
9	ERJ-8GEY0R00V	4	RL1, RL2, RL3, RL4	P0.0ECT	RESISTOR SMD1206 0.0 OHM 5% 1/4W ROHS	DIGI-KEY	PANASONIC		
10	ESR10EZPJ100	4	R9,R10,R11,R12	RHM10KCT	RESISTOR SMD0805 10 OHM 1% 1/4W ROHS	DIGI-KEY	ROHM		
11	ERJ-8ENF10R0	1	R5	P10.0FCT	RESISTOR SMD1206 10.0 OHM 1% 1/4W ROHS	DIGI-KEY	PANASONIC		
12	RC0603FR-071KL	1	R6	311-1.00KHRCT	RESISTOR SMD0603 1.00K OHM 1% 1/10W ROHS	DIGI-KEY	YAGEO		
13	ERJ-3GEYJ103V	1	R8	P10KGCT	RESISTOR SMD0603 10K 5% 1/10W ROHS	DIGI-KEY	PANASONIC		
14	3303W-3-103E	1	R7	3303W-103ECT	POT 10K SMD SINGLE TURN CERMET ROHS	DIGI-KEY	BOURNS		
15	ERJ-3EKF1003V	3	R1,R2,R3	P100KHCT	RESISTOR SM0603 100K OHM 1% 1/16W ROHS	DIGI-KEY	PANASONIC		
				FERRITE BEADS					
16	HI1812V101R-10	6	FB1, FB2, FB3, FB4, FB5, FB6	240-2543-1	FERRITE BEAD SMD1812 125 OHM@100MHz 8A ROHS	DIGI-KEY	STEWARD		
				HEADERS AND JACKS					
17	PBC02SAAN	11	JP1, JP2, JP3, JP4, JP5, JP6, JP7, JP8, PBTL, GAIN0, GAIN1	S1011E-02	HEADER 2 PIN MALE, PCB STRAIGHT GOLD ROHS	DIGI-KEY	SULLINS		



Schematic, Layout, and Bill of Materials

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Table 4. Bill of Materials for TPA3110D2EVM	(continued)
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22-23-2021 PJRAN1X1U01X PJRAN1X1U03X	2 1 1	LEFT, RIGHT LIN	WM4200 65K7770	HEADER MALE 2PIN 100LS W/ FRICTION LOCK ROHS JACK, RCA 3-PIN PCB-RA	DIGI-KEY	MOLEX
PJRAN1X1U01X PJRAN1X1U03X	1	LIN	65K7770	JACK, RCA 3-PIN PCB-RA		
PJRAN1X1U03X	1	RIN		BLACK ROHS	NEWARK	SWITCHCRAFT
	1		89K7617	JACK, RCA 3-PIN PCB-RA RED ROHS	NEWARK	SWITCHCRAFT
			TESTPOINTS AND SWIT	CHES		
5004	7	SD, TP1, TP2, TP3, TP4, FAULT, PLIMIT	5004K	PC TESTPOINT, YELLOW, ROHS	DIGI-KEY	KEYSTONE ELECTRONICS
5001	3	AGND, PGND1, PGND2	5001K	PC TESTPOINT, BLACK, ROHS	DIGI-KEY	KEYSTONE ELECTRONICS
TL1015AF160QG	1	S1	EG4344CT	SWITCH, MOM, 160G SMT 4X3MM ROHS	DIGI-KEY	E-SWITCH
			BINDING POSTS			
3760-2	2	LEFT+, RIGHT+	565-3760-2	BINDING POST, RED 60V/15A TIN ROHS	MOUSER	POMONA
3760-0	2	LEFT-, RIGHT-	565-3760-0	BINDING POST, BLACK 60V/15A TIN ROHS	MOUSER	POMONA
3750-2	1	PVCC	565-3750-2	BINDING POST, RED 60V/15A GOLD ROHS	MOUSER	POMONA
3750-0	1	GND	565-3750-0	BINDING POST, BLACK 60V/15A GOLD ROHS	MOUSER	POMONA
			SHUNTS			
SPC02SYAN	11	JP1, JP2, JP3, JP4, JP5, JP6, JP7, JP8, PBTL, GAIN0, GAIN1	S9001	SHUNT, BLACK AU FLASH 0.100LS	DIGI-KEY	SULLINS
			STANDOFFS AND HARD	WARE		
PMS 440 0025 PH	4	SO1-S04	H342	4-40 SCREW, STEEL 0.250 IN	DIGI-KEY	BUILDING FASTENERS
2030	4	SO1-S04	2030K	STANDOFF,4- 40,0.875INx3/16IN,ALUM RND F-F	DIGI-KEY	KEYSTONE ELECTRONICS
	+	C	OMPONENTS NOT ASSE	MBLED	+	I
500 500 500 500 500 500 500 500 500 500	104 101 1015AF160QG 760-2 760-0 750-2 750-0 PC02SYAN MS 440 0025 PH 1330 26, C27, L1, L2, L3, L4	104 7   101 3   .1015AF160QG 1   760-2 2   760-0 2   750-2 1   750-2 1   PC02SYAN 11   MS 440 0025 PH 4   230 4	104   7   SD, TP1, TP2, TP3, TP4, FAULT, PLIMIT     101   3   AGND, PGND1, PGND2     .1015AF160QG   1   S1     '60-2   2   LEFT+, RIGHT+     '60-0   2   LEFT-, RIGHT-     '750-2   1   PVCC     '750-0   1   GND     PC02SYAN   11   JP1, JP2, JP3, JP4, JP5, JP6, JP7, JP8, PBTL, GAIN0, GAIN1	104     7     SD, TP1, TP2, TP3, TP4, FAULT, PLIMIT     5004K       101     3     AGND, PGND1, PGND2     5001K       .1015AF160QG     1     S1     EG4344CT       BINDING POSTS       760-2     2     LEFT+, RIGHT+     565-3760-2       760-0     2     LEFT-, RIGHT-     565-3760-0       750-2     1     PVCC     565-3750-2       750-0     1     GND     565-3750-0       SHUNTS       PC02SYAN     11     JP1, JP2, JP3, JP4, JP5, JP6, JP7, JP8, PBTL, GAINO, GAIN1     S9001       STANDOFFS AND HARD       MS 440 0025 PH     4     SO1-S04     H342       030     4     SO1-S04     2030K	104     7     SD, TP1, TP2, TP3, TP4, FAULT, PLIMIT     5004K     PC TESTPOINT, YELLOW, ROHS       101     3     AGND, PGND1, PGND2     5001K     PC TESTPOINT, BLACK, ROHS       .1015AF160QG     1     S1     EG4344CT     SWITCH, MOM, 160G SMT 4X3MM ROHS       BINDING POSTS       *60-2     2     LEFT+, RIGHT+     565-3760-2     BINDING POST, BLACK 60V/15A TIN ROHS       *60-0     2     LEFT-, RIGHT-     565-3760-0     BINDING POST, BLACK 60V/15A TIN ROHS       *50-2     1     PVCC     565-3750-2     BINDING POST, BLACK 60V/15A GOLD ROHS       *50-0     1     GND     565-3750-0     BINDING POST, BLACK 60V/15A GOLD ROHS       *50-0     1     GND     565-3750-0     BINDING POST, BLACK 60V/15A GOLD ROHS       *50-0     1     GND     565-3750-0     BINDING POST, BLACK 60V/15A GOLD ROHS       *50-0     1     JP1, JP2, JP3, JP4, JP5, JP6, JP7, JP8, PBTL, GAINO, GAIN1     S9001     SHUNT, BLACK AU FLASH 0.100LS       ************************************	104     7     SD, TP1, TP2, TP3, TP4, FAULT, PLIMIT     5004K     PC TESTPOINT, YELLOW, ROHS     DIGHKEY       101     3     AGND, PGND1, PGND2     5001K     PC TESTPOINT, VELLOW, ROHS     DIGHKEY       .1015AF160QG     1     S1     EG4344CT     SWITCH, MOM, 160G SMT 4X3MM ROHS     DIGHKEY       BINDING POSTS       '60-2     2     LEFT+, RIGHT+     565-3760-2     BINDING POST, RED 60V/15A TIN ROHS     MOUSER       *60-0     2     LEFT-, RIGHT-     565-3760-0     BINDING POST, BLACK 60V/15A TIN ROHS     MOUSER       *50-2     1     PVCC     565-3750-2     BINDING POST, RED 60V/15A GOLD ROHS     MOUSER       *50-0     1     GND     565-3750-0     BINDING POST, RED 60V/15A GOLD ROHS     MOUSER       *50-0     1     GND     565-3750-0     BINDING POST, BLACK 60V/15A GOLD ROHS     MOUSER       *50-0     1     GND     565-3750-0     BINDING POST, BLACK 60V/15A GOLD ROHS     MOUSER       *50-0     1     JP1, JP2, JP3, JP4, JP5, JP6, JP7, JP8, PBTL, GAINO, GAIN1     SHUNT, BLACK AU FLASH     DIGHKEY       *300     <



# **Revision History**

Changes from A Revision (July 2010) to B Revision				
•	Replaced Figure 3	6		
•	Replaced Figure 4	7		
•	Replaced Figure 5	8		

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

### STANDARD TERMS AND CONDITIONS FOR EVALUATION MODULES

- 1. Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, or documentation (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms and conditions set forth herein. Acceptance of the EVM is expressly subject to the following terms and conditions.
  - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms and conditions that accompany such Software
  - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
- 2 Limited Warranty and Related Remedies/Disclaimers:
  - 2.1 These terms and conditions do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
  - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for any defects that are caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI. Moreover, TI shall not be liable for any defects that result from User's design, specifications or instructions for such EVMs. Testing and other quality control techniques are used to the extent TI deems necessary or as mandated by government requirements. TI does not test all parameters of each EVM.
  - 2.3 If any EVM fails to conform to the warranty set forth above, TI's sole liability shall be at its option to repair or replace such EVM, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.
- 3 Regulatory Notices:
  - 3.1 United States
    - 3.1.1 Notice applicable to EVMs not FCC-Approved:

This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

### CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

### FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

### **Concerning EVMs Including Radio Transmitters:**

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

#### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

#### **Concerning EVMs Including Detachable Antennas:**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

#### Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

#### 3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see <a href="http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page">http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page</a> 日本国内に 輸入される評価用キット、ボードについては、次のところをご覧ください。 http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

【無線電波を送信する製品の開発キットをお使いになる際の注意事項】開発キットの中には技術基準適合証明を受けて いないものがあります。 技術適合証明を受けていないもののご使用に際しては、電波法遵守のため、以下のいずれかの 措置を取っていただく必要がありますのでご注意ください。

- 1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用 いただく。
- 2. 実験局の免許を取得後ご使用いただく。
- 3. 技術基準適合証明を取得後ご使用いただく。
- なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。 上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。 日本テキサス・イ

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- 3.3.3 Notice for EVMs for Power Line Communication: Please see <a href="http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_02.page">http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_02.page</a> 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_02.page
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